

12-04-2006

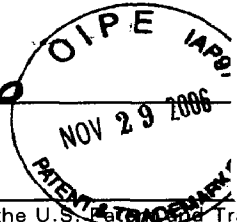
U.S. DEPARTMENT OF COMMERCE



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To the Director of the U.S. Patent and Trademark Office: Please record the attached document.



1. Name of conveying party(ies):

TORAY INDUSTRIES, INC.

2. Name and Address of receiving party(ies):

TORAY ENGINEERING CO., LTD.
Nohonbashi Muromachi Bldg.
3-3-16, Nohonbashi-Hongokucho
Chuo-ku, Tokyo 103-0021
JAPAN

3. Nature of conveyance:

Assignment Merger
 Security Agreement Change of Name
 Other: _____

Execution Date(s): October 20, 2006

4. Application number(s) or patent number(s):

This document is being filed together with a new application.

OR

This document is being filed after filing of the application:

(a) Patent Application No(s). _____, filed _____; or

(b) Patent No(s). 6,440,338, issued August 27, 2002.

5. Name and address of party to whom correspondence concerning document should be mailed:

STAAS & HALSEY LLP Our Docket: 0392.1683
Attention: H. J. Staas
1201 New York Ave., N.W., 7th Floor
Washington, D.C. 20005

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)..... (\$ 40.00 per Patent or Application in Assignment)

Enclosed
 Authorized to be charged to deposit account.

8. Deposit Account No.: 19-3935 (Any underpayment is authorized to be charged to this Deposit Account)

(Attach duplicate copy of this page if paying by deposit account)

H. J. Staas, Reg. No. 22,010
Name of Person Signing

Signature

Nov, 27, 2006
Date

Total number of pages including cover sheet: 2

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ASSIGNMENT

WHEREAS, **TORAY INDUSTRIES, INC.**, a corporation of Japan, residing at 1-1, Nihonbashi Muromachi 2-chome, Chuo-ku, Tokyo, 103-8666 Japan (hereinafter, "**ASSIGNOR**"), is a non-exclusive co-owner, by Assignment, in accordance with an Assignment recorded **July 11, 2000** at Reel/Frame **010976/0675** in the U.S. Patent and Trademark Office ("**Recorded Assignment**") of the following U.S. patent:

U.S. Patent No. 6,440,338, titled: METHOD, APPARATUS, AND MEDIUM FOR FORMING MOLDING CONDITION AND MOLDING MACHINE, issued August 27, 2002.

WHEREAS, **TORAY ENGINEERING CO., LTD.**, a corporation of Japan, residing at Nihonbashi Muromachi Bldg., 3-3-16, Nohonbashi-Hongokucho, Chuo-ku, Tokyo 103-0021, Japan (hereinafter "**ASSIGNEE**") is desirous of acquiring the entire, right, title and interest of the aforesaid **ASSIGNOR** in the aforesaid patent;

IN CONSIDERATION of good and valuable consideration paid to the undersigned **ASSIGNOR**, the receipt and sufficiency of which are hereby acknowledged, the undersigned **ASSIGNOR** hereby sells, assigns and transfers to **ASSIGNEE** and its successors, assigns and legal representatives, the entire, right, title and interest of the aforesaid **ASSIGNOR**, acquired heretofore by the **Recorded Assignment**, of the aforesaid patent or patents issuing therefrom or from any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which said patent(s) may be granted and including any extensions thereof.

The **ASSIGNOR** and **ASSIGNEE** agree, when requested by the other, to do all acts which the other may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate Assignments and Declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

The **ASSIGNOR** covenants with the **ASSIGNEE**, its successors, assigns and legal representatives, that the rights and property herein conveyed are free and clear of any encumbrance, and that the **ASSIGNOR** has the full right to convey same as herein expressed.

For **ASSIGNOR, TORAY INDUSTRIES, INC.**

Signature

Date Signed

Witness(es)

By: Hiroaki Kobayashi
Name: Hiroaki KOBAYASHI
Title: Executive Vice President

October 20, 2006

Koichi Yonezawa
Koichi YONEZAWA
Senior Staff